Letter

Solid-state structure of the naphthalene-based n-type semiconductor, and performance improved with Mo-based source/drain electrodes

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ABSTRACT

The synthesis, single-crystal structures, and device performance of novel naphthalene-diimide are described. The crystal structure has revealed the importance of a withdrawing group on solid-state packing. Molybdenum as source/drain (S/D) electrodes can improve the performance of the bottom-contact device. The bottom-contact device based on a material of \( \text{N,N'-bis(4-trifluoromethoxybenzyl)naphthalene-1,4,5,8-tetracarboxylic acid diimide} \) has a high mobility of \( 3.58 \times 10^{-2} \) cm\(^2\) V\(^{-1}\) s\(^{-1}\), a threshold voltage of 1.3 V, and an on/off current ratio of 5.2 \( \times 10^3 \).

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1. Introduction

The use of organic materials as the semiconductor layer provides a number of advantages, including: low-temperature process, large-area spin coating, inject printing, etc. [1,2]. Many reports have illustrated the characteristics of organic thin-film transistors (OTFTs) using pentacene, a well-known material used as p-type organic transistor [3,4]. For the n-type organic transistor, air-stable and high electron-transporting materials are crucial to the development of the high performance device [5–7]. In recent studies, Katz et al. [8] demonstrated that air-stable n-type organic transistors (OTFTs) using pentacene, a well-known material used as a semiconductor, air-stable and high electron-transporting materials are crucial to the development of the high performance device[5–7].

In this paper, we synthesize two n-type materials, and Fig. 1 shows the chemical structure. Crystal data on NTCDI–OCH\(_3\) and NTCDI–OCF\(_3\) are estimated by single-crystal X-ray diffraction. In single-crystal structure, close packing between each molecular structure is shown in NTCDI–OCF\(_3\), indicating that the material functioning with “4-trifluoromethoxybenzyl” would resist the electric decay from ambient condition. To improve the device’s performance, we varied the S/D electrodes, which were molybdenum (Mo), indium–tin oxide (ITO), and molybdenum–tungsten alloy (MoW), in our studies. A high mobility of \( 3.58 \times 10^{-2} \) cm\(^2\) V\(^{-1}\) s\(^{-1}\) was measured with Mo-based S/D electrodes, fabricated without surface treatments, and then operated in air.

2. Experiments

2.1. Synthesis

Chemical reagents were obtained from Alfa Aesar, Acros Organics, and Tokyo Chemical Industry Co., and were used without further purification. Compounds (a) and (b) were synthesized by the same procedure.

\( \text{N,N'-bis(4-methoxybenzyl)naphthalene-1,4,5,8-tetracarboxylic acid diimide (NTCDI–OCH}_3\text{ (a))} \). A mixture of 1.50 g (5.59 mmol) of 1,4,5,8-naphthalene-tetracarboxylic dihydride, 2.67 g (13.98 mmol) of 4-methoxy benzylamine, and 10 g (0.14 mol) of imidazole was heated to 100 °C for 30 min. Then, the temperature was increased to 110 °C for 12 h under the inert system. The crude mixture was put into diluted hydrochloric acid. Thereafter, the precipitate was filtered, washed with D.I. water, and dried in a vacuum at 80 °C. The remaining solid was purified at least twice by gradient-temperature sublimation. The compound was fully characterized by \(^1\)H, \(^13\)C NMR spectroscopy, Elmass spectrometry, and elemental analysis. (NTCDI–OCH\(_3\)):

- Yield 65%;
- \(^1\)H NMR (500 Hz, CDCl\(_3\)) \( \delta 8.76 \) (s, 4H), \( \delta 7.51 \) (d, \( J = 8.5 \) Hz, 4H), \( \delta 6.84 \) (d, \( J = 8.5 \) Hz, 4H), \( \delta 5.32 \) (s, 4H), \( \delta 3.76 \) (s, 6H); \(^13\)C NMR (100 Hz, CDCl\(_3\)) \( \delta 162.84 \), 131.09, 130.81, 126.71, 113.88, 55.23, 43.44; El-MS: calcd. MW, 506.5; m/e = 506 (M+H\(^+\))\(^\ast\); Anal. Found (calcd.) for C\(_30\)H\(_{16}\)F\(_6\)N\(_2\)O\(_6\): C 58.64 (58.65); H 2.62 (2.62); N 5.53 (5.53); A.

- Yield 45%; \(^1\)H NMR (500 Hz, CDCl\(_3\)) \( \delta 8.74 \) (s, 4H), \( \delta 7.51 \) (d, \( J = 8.5 \) Hz, 4H), \( \delta 6.84 \) (d, \( J = 8.5 \) Hz, 4H), \( \delta 5.32 \) (s, 4H), \( \delta 3.76 \) (s, 6H); El-MS: calcd. MW, 506.5; m/e = 506 (M+H\(^+\))\(^\ast\); Anal. Found (calcd.) for C\(_30\)H\(_{16}\)F\(_6\)N\(_2\)O\(_6\): C 71.14 (71.14); H 4.38 (4.66); N 5.53 (5.92).

\( \text{N,N'-bis(4-trifluoromethoxybenzyl)naphthalene-1,4,5,8-tetracarboxylic acid diimide (NTCDI–OCF}_3\text{ (b))} \). (NTCDI–OCF\(_3\)):

- Yield 45%; \(^1\)H NMR (500 Hz, CDCl\(_3\)) \( \delta 8.74 \) (s, 4H), \( \delta 7.59 \) (d, \( J = 8.5 \) Hz, 4H), \( \delta 7.15 \) (d, \( J = 8.0 \) Hz, 4H), \( \delta 5.36 \) (s, 4H); \(^13\)C NMR (100 Hz, CDCl\(_3\)) \( \delta 162.75 \), 148.81, 135.12, 131.29, 128.08, 126.73, 121.41, 121.04, 119.36, 43.26; El-MS: calcd. MW, 614.0; m/e = 614.0 (M+H\(^+\))\(^\ast\); Anal. Found (calcd.) for C\(_30\)H\(_{16}\)F\(_6\)N\(_2\)O\(_6\): C 58.64 (58.65); H 2.62 (2.04); N 4.56 (4.81).
2.2. Crystal growth

Single crystals of compounds (a) and (b) were grown by solvent-evaporation method, from a N,N-dimethylacetamine (DMAC). The mixture was stirred and carefully heated until total dissolution. Then the solution was left to rest for a period of time. Crystals were obtained by slowly dropping the temperature.

2.3. Device fabrication

Organic thin-film transistors were fabricated using the bottom-contact design, in which S/D electrodes were deposited on the dielectric layer, after which the organic semiconductor was allowed to completely evaporate. A layer of 100 nm indium–tin oxide, the gate electrode, was sputtered onto the glass substrate and patterned through a method of lithography. The dielectric layer of 300 nm silicon dioxide (SiO₂) was grown by plasma-enhanced chemical vapor (PECVD), deposited on the top of the gate electrode. A 100-nm thin-film of metal (Mo, ITO, or MoW) was sputtered and patterned onto the SiO₂, serving as the S/D electrodes, with the defined channel length and width being 30 and 500 μm, respectively. Finally, the organic semiconductor was evaporated onto the active channel in a high vacuum chamber (2 × 10⁻⁶ Torr) to finish the process. In order to optimize device performance, we maintained a substrate temperature of 100 °C for evaporating compound (a) and 40 °C for compound (b). Materials were purified via gradient-temperature sublimation, which we used as the semiconductor layer.

3. Results and discussion

3.1. Crystal structures of materials (a) and (b)

Single crystals of NTCDI–OCH₃ (a) and NTCDI–OCF₃ (b) were analyzed by an X-ray single-crystal diffractometer (Nonius Kappa CCD Axis). Both compounds (a) and (b) can grow to an observed size from the dissolved solution. As shown in Fig. 2(a) and (b), ca. a 1.5-mm length of single crystals was found through optical microscopy. Well-crystalline material would be suitable for use as organic semiconductor because a reduced grain boundary existed in the well-packing state. For compound (a), the molecular and crystallographic packing structures and the conjugate center-core of each molecular unit packed along the a-axis, are shown in Figs. 3–5. The crystal structure reveals herringbone packing, for which the distance of 4.36 Å between each center-core was found. Contact distances from one atom to an adjacent one are estimated as: O₃–C₁₂ at 4.13 Å, O₃–C₉ at 6.67 Å and O₃–N₁ at 2.31 Å.
Fig. 4. Crystal packing of NTCDI–OCH$_3$ on the $ac$ plane.

Fig. 5. Molecular stacking of NTCDI–OCH$_3$ projected on the three-dimensional packing.
A single crystal for compound (b) was also obtained, as shown in Figs. 6–8, as well as the conjugated center-core of each molecular unit packed along the c-axis. The distance of 3.62 Å between each center-core was found. Contact distances from one atom to an adjacent one are found to be: O₃–C₁₀ at 1.21 Å, O₃–C₁₁ at 2.37 Å, and O₃–N₁ at 2.27 Å. Here, we found that molecular contacts for compound (b) are shorter than those for compound (a), and that this short contact allows molecular unit (b) to have more planar subunits within one stacking unit. Molecules that are constructed via the electron-withdrawing groups would effectively help n-type organic materials to resist oxygen and moisture. The electric characteristic of OTFTs using compound (a) was such that the active layer was unable to operate in air, and its low carrier mobility ca. 1 × 10⁻¹¹ cm² V⁻¹ s⁻¹ was estimated under vacuum condition. Crystal structures of compounds (a) and (b) proved that materials including the fluoro-group would cause well-packing, and would be good for n-type materials. Table 1 shows detailed crystal data on compounds (a) and (b).

### 3.2. OTFT characteristics

Bottom-contact devices were fabricated with three different S/D electrodes (Mo, ITO, and MoW), and NTCDI–OCF₃ (b) which operated in air and acted as the organic semiconductor (Fig. 9). We have demonstrated that the “–OCF₃” group would be suitable for the bottom-contact type of OTFTs [11]. Figs. 10–12 show transfer characteristics for OTFTs of Mo-, ITO-, and MoW-based S/D electrodes (each inset is the output characteristic), and Table 2 compares the device performance of three OTFTs. In previous research, metalwork function of Mo, ITO, and MoW was 4.5, 4.7, and 5.0 eV, respectively [12,13]. Low-work-function metals were expected to reduce barriers between electrodes and semiconduct-

### Table 1

<table>
<thead>
<tr>
<th>Crystallographic data of NTCDI–OCF₃ and NTCDI–OCH₃</th>
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<tr>
<td><strong>Formula</strong></td>
</tr>
<tr>
<td><strong>Crystal system</strong></td>
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<tr>
<td><strong>Space group</strong></td>
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<tr>
<td><strong>Cell volume (Å³)</strong></td>
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<td><strong>Density (g/cm³)</strong></td>
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<td><strong>a (Å)</strong></td>
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<td><strong>b (Å)</strong></td>
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<td><strong>c (Å)</strong></td>
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<td><strong>β (°)</strong></td>
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### Table 2

<table>
<thead>
<tr>
<th>Source/drain electrodes</th>
<th>Mobility (× 10⁻² cm² V⁻¹ s⁻¹)</th>
<th>Threshold voltage (V)</th>
<th>On/off current ratio (× 10⁵)</th>
</tr>
</thead>
<tbody>
<tr>
<td>1 Molybdenum (Mo)</td>
<td>3.58</td>
<td>1.3</td>
<td>5.2</td>
</tr>
<tr>
<td>2 Indium–tin oxide (ITO)</td>
<td>1.09</td>
<td>5.7</td>
<td>2.1</td>
</tr>
<tr>
<td>3 Molybdenum–tungsten (MoW)</td>
<td>1.01</td>
<td>10.6</td>
<td>1.3</td>
</tr>
</tbody>
</table>
As a result, a high mobility of $3.58 \times 10^{-2} \text{cm}^2 \text{V}^{-1} \text{s}^{-1}$ was obtained by using a Mo-based bottom-contact device. For n-type OTFTs, low-work-function metals have lower electron injection barriers, which lead to a smaller output voltage for driving transistors. A lower threshold voltage of 1.3 V can be seen in the electric characteristic of the Mo-based device, and the threshold voltage of ITO-, and MoW-based devices were 5.7 and 10.6 V, respectively. Larger barriers resulted in increasing output voltage (indicating that devices need to offset the high barrier), and caused larger

**Fig. 8.** Molecular stacking of NTCDI–OCF$_3$ projected on the three-dimensional packing.

**Fig. 9.** Schematic diagram of bottom-contact device. W/L = 500/30 μm.

**Fig. 10.** Transfer characteristics of Mo-based S/D electrodes (VD = +50 V). The inset is the output characteristics.
threshold voltage. Furthermore, bottom-contact devices were fabricated without further surface treatments (surface of SiO$_2$ or S/D electrodes), and all measurements were carried out in an ambient environment.

3.3. AFM images and X-ray diffraction

Fig. 13 displays thin-film morphology for compound (b) which was deposited onto varied substrates: substrates of SiO$_2$ (A, a); Mo (B, b); ITO (C, c); and MoW (D, d). Images in Fig. 13 (A–D) were obtained by atomic force microscopy (AFM, Digital Instruments Nanoscope), while (a–d) were phase images. The morphology on the surface of SiO$_2$ is similar to ITO, with its continuing rod-like packing. The morphology of small-grain packing is found on the surface of Mo and MoW. X-ray diffraction patterns conform to thin-film morphology, and in Fig. 14, the diffraction intensity associated with depositing on the surface of SiO$_2$ is as strong as ITO. Furthermore, X-ray diffraction measurements of the vapor-deposited thin-films on the SiO$_2$ correspond well with the reflections from the single-crystal data. The calculated $d$-spacing of 20.1 Å is quite similar to the estimated value of the single-crystal structure, confirming that the molecule is perpendicular to the surface of SiO$_2$.
4. Conclusions

We report single-crystal data of NTCDI–OCH$_3$ and NTCDI–OCF$_3$, and closer crystal packing of NTCDI–OCF$_3$ which can serve as the active layer. High-mobility bottom-contact devices were based on an air-stable n-type organic semiconductor, NTCDI–OCF$_3$, with a mobility of $3.58 \times 10^{-2}$ cm$^2$ V$^{-1}$ s$^{-1}$, a threshold voltage of +1.3 V, and an on/off current ratio of $5.2 \times 10^5$. The bottom-contact device was fabricated without further surface treatment, and devices can operate in air. Mo-based S/D electrodes which have low-work-function are suitable for the electron-transporting material, because low-work-function metals have lower electron injection barriers.

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References